

L Number	Hits	Search Text	DB	Time stamp
1	1784	(438/611-618).CCLS.	USPAT	2002/11/15 17:56
2	98	((438/611-618).CCLS.) and PBGA cbga	USPAT	2002/11/15 17:56
3	62	((438/611-618).CCLS.) and PBGA cbga) and PBGA cbga and lead\$1free	USPAT	2002/11/15 18:01
4	0	((438/611-618).CCLS.) and PBGA cbga) and (PBGA cbga) and lead\$1free	USPAT	2002/11/15 17:59
5	0	((438/611-618).CCLS.) and PBGA cbga) and (PBGA cbga) and ((lead pb) adj free)	USPAT	2002/11/15 17:59
6	62	((438/611-618).CCLS.) and PBGA cbga) and PBGA cbga and (sn tin) near2 (sb antimony)	USPAT	2002/11/15 18:12
7	0	((438/611-618).CCLS.) and PBGA cbga) and (PBGA cbga) and (sn tin) near2 (sb antimony)	USPAT	2002/11/15 18:02
8	63128	257/\$.ccls.	USPAT	2002/11/15 18:14
9	50494	438/\$.ccls.	USPAT	2002/11/15 18:15
11	35263	148/\$.ccls.	USPAT	2002/11/15 18:15
12	22490	228/\$.ccls.	USPAT	2002/11/15 18:15
13	212	(reduc\$5 lower\$3 diminish\$3 diminution) near2 (solder\$1 bump\$1) near2 (height high thickness)	USPAT	2002/11/15 18:36
14	118	((reduc\$5 lower\$3 diminish\$3 diminution) near2 (solder\$1 bump\$1) near2 (height high thickness)) and (257/\$.ccls. 438/\$.ccls. 148/\$.ccls. 228/\$.ccls.)	USPAT	2002/11/15 18:22
15	1	((reduc\$5 lower\$3 diminish\$3 diminution) near2 (solder\$1 bump\$1) near2 (height high thickness)) and (257/\$.ccls. 438/\$.ccls. 148/\$.ccls. 228/\$.ccls.)) and (reduc\$5 lower\$3 diminish\$3 diminution) near2 (solder\$1 bump\$1) near2 (height high thickness) near5 ("% percent\$3)	USPAT	2002/11/15 18:37